

# **STF9N60M2, STFI9N60M2**

## N-channel 600 V, 0.72 Ω typ., 5.5 A MDmesh II Plus™ low Q<sub>g</sub> Power MOSFETs in TO-220FP and I<sup>2</sup>PAKFP packages

Datasheet - production data

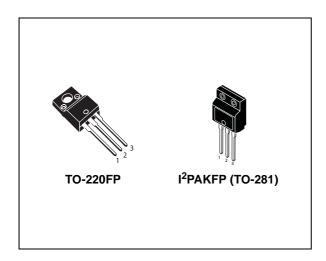
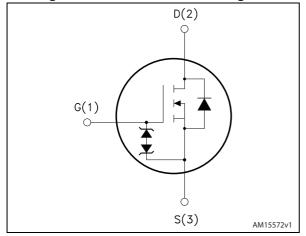


Figure 1. Internal schematic diagram



#### **Features**

Order codes	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STF9N60M2	650 V	0.78 Ω	5.5 A
STFI9N60M2	000 V	0.70 32	0.07

- Extremely low gate charge
- Lower R<sub>DS(on)</sub> x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

#### **Applications**

· Switching applications

#### **Description**

These devices are N-channel Power MOSFETs developed using a new generation of MDmesh<sup>TM</sup> technology: MDmesh II Plus<sup>TM</sup> low  $Q_g$ . These revolutionary Power MOSFETs associate a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. They are therefore suitable for the most demanding high efficiency converters.

**Table 1. Device summary** 

Order codes	Marking	Package	Packaging
STF9N60M2	9N60M2	TO-220FP	Tube
STFI9N60M2	91400IVIZ	I <sup>2</sup> PAKFP	Tube

### **Contents**

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# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	5.5 <sup>(1)</sup>	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	3.6 <sup>(1)</sup>	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	22 <sup>(1)</sup>	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	20	W
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T <sub>C</sub> =25 °C)	2500	V
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/115
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	

<sup>1.</sup> Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Symbol Parameter		Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	6.25	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W

**Table 4. Avalanche characteristics** 

Symbol	Symbol Parameter		Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	2	Α
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j$ =25°C, $I_D$ = $I_{AR}$ ; $V_{DD}$ =50)	105	mJ

<sup>2.</sup>  $I_{SD} \leq 5.5 \text{ A, di/dt} \leq 400 \text{ A/µs; V}_{DS \text{ peak}} < V_{(BR)DSS}, V_{DD} = 400 \text{ V}$ 

 $<sup>3. \</sup>quad V_{DS} \leq \ 480 \ V$ 

### 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	600			V
1	Zero gate voltage	V <sub>DS</sub> = 600 V			1	μΑ
I <sub>DSS</sub>	drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 600 V, T <sub>C</sub> =125 °C			100	μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 25 V			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A		0.72	0.78	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	320	-	pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 100 \text{ V, f} = 1 \text{ MHz,}$	-	18	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	0.68	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$	-	88	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	6.5	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 5.5 A,	-	10	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	2	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15)	-	5.1	-	nC

Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	8.8	-	ns
t <sub>r</sub>	Rise time	$V_{DD} = 300 \text{ V}, I_D = 3 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	7.5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	$ C_G = 4.7 \Omega_S, V_{GS} = 10 V$ (see <i>Figure 14</i> and <i>Figure 19</i> )	-	22	-	ns
t <sub>f</sub>	Fall time		-	13.5	-	ns



Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		5.5	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		22	Α
V <sub>SD</sub> (2)	Forward on voltage	$I_{SD} = 5.5 \text{ A}, V_{GS} = 0$	-		1.6	V
t <sub>rr</sub>	Reverse recovery time		-	265		ns
Q <sub>rr</sub>	Reverse recovery charge	$I_{SD} = 5.5 \text{ A}$ , di/dt = 100 A/µs   $V_{DD} = 60 \text{ V}$ (see <i>Figure 16</i> )	-	1.65		μC
I <sub>RRM</sub>	Reverse recovery current		-	12.5		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 5.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	377		ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$	-	2.3		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16)	-	12.2		Α

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

(A)

0.1

### 2.1 Electrical characteristics (curves)

100µs

1ms

10ms

V<sub>D</sub>s(V)

Figure 2. Safe operating area

AM15863v1

Tj=150°C

Single pulse

Figure 3. Thermal impedance

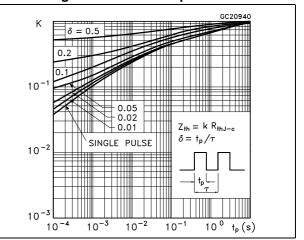
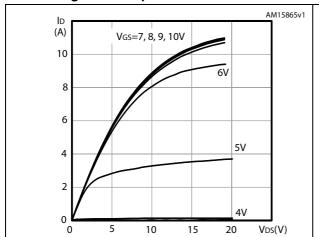


Figure 4. Output characteristics

Figure 5. Transfer characteristics



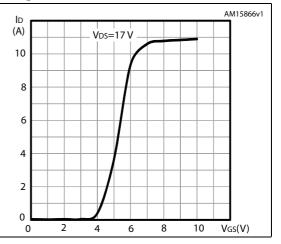
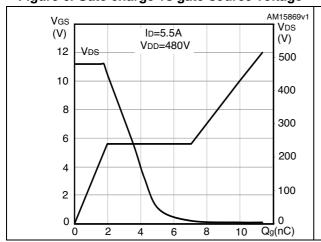
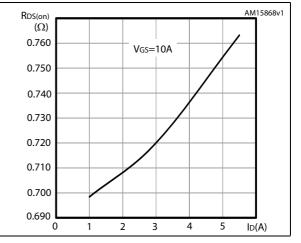


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance





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Figure 8. Capacitance variations

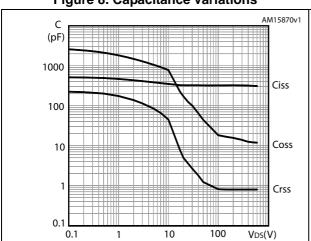


Figure 9. Output capacitance stored energy

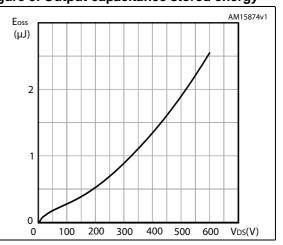
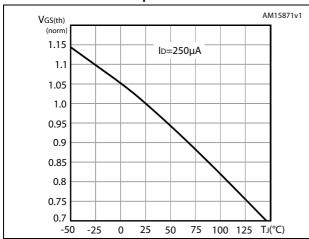


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



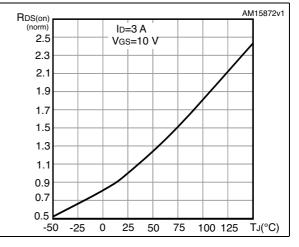
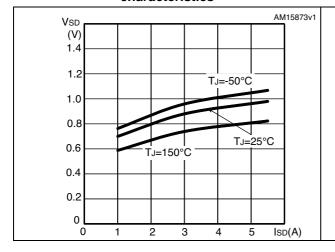
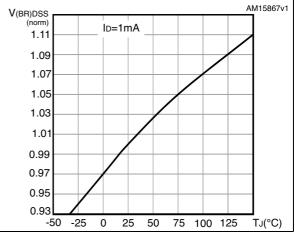


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized  $V_{(BR)DSS}$  vs temperature





### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

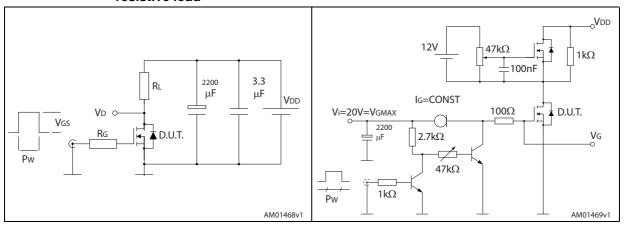


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

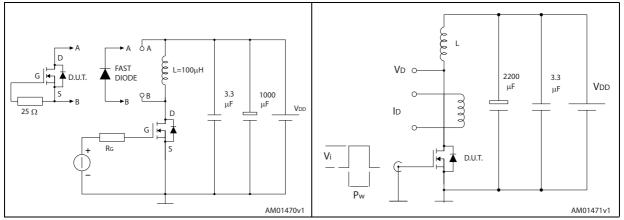
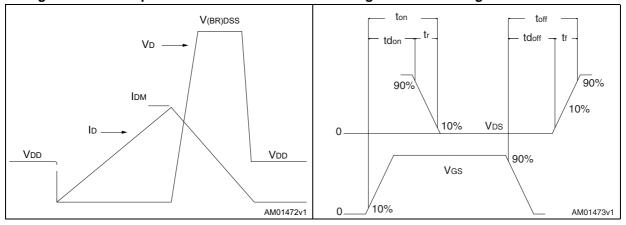


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



#### **TO-220FP, STF9N60M2** 4.1

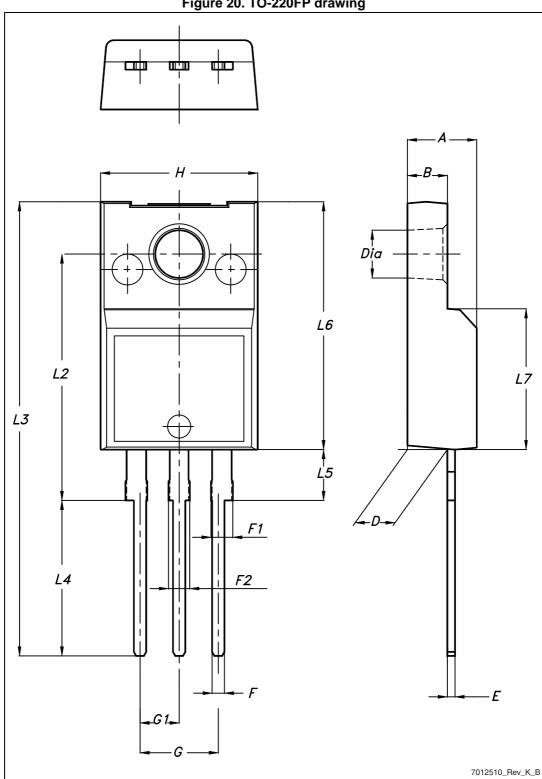


Figure 20. TO-220FP drawing

Table 9. TO-220FP mechanical data

		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

# 4.2 I<sup>2</sup>PAKFP (TO-281), STFI9N60M2

Figure 21. I<sup>2</sup>PAKFP (TO-281) drawing

Table 10. I<sup>2</sup>PAKFP (TO-281) mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
В	2.50		2.70
D	2.50		2.75
D1	0.65		0.85
E	0.45		0.70
F	0.75		1.00
F1			1.20
G	4.95	-	5.20
Н	10.00		10.40
L1	21.00		23.00
L2	13.20		14.10
L3	10.55		10.85
L4	2.70		3.20
L5	0.85		1.25
L6	7.30		7.50



# 5 Revision history

**Table 11. Document revision history** 

Date	Revision	Changes
03-Jun-2013	1	First release.The part number was previously included in datasheet DocID024399.
10-Mar-2014	2	Added: I <sup>2</sup> PAKFP package Minor text changes

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